II. CLAIM AMENDMENTS

1-13. (Previously Withdrawn)

- 14. (Currently Amended) A contact for establishing an electrical connection between a first electronic device and a second electronic device, the contact comprising:
 - a flexible conductive body formed in a first position and adapted to be set into a second, compressed position and activated into a third, expanded position in order to accommodate a variable gap between the first electronic device and the second electronic device for establishing the electrical connection.
- 15. (Currently Amended) A contact in accordance with Claim 14 wherein the contact, in the second position, may be in a compressed state, a second position, and upon heat activation of a shape memory material, the contact translates to athe third position, being the uncompressed state expanded position.
- 16. (Currently Amended) A contact in accordance with Claim 1415 for use in an interposer wherein the shape memory material is a nickel titanium alloy.

- 17. (Currently Amended) A contact in accordance with Claim 1415 wherein the shape memory material has a martinsitic transition temperature in the range between -20 to 100 degrees C.
 - 18. (Currently Amended) A contact in accordance with Claim 1415 further comprising the shape memory material being superelastic.
 - 19. (Original) A contact in accordance with Claim 14 wherein the electrical contact is selected from the contacts having a shape of an E, a C, a Random coil spring, and a helical spring.
- 20. (New) A contact for forming an electrical connector between a first electronic device and at least a second electronic device comprising:
 - a conductive body adapted to be formed in a first, uncompressed state, deformed into a second compressed state that is maintained until the body is activated to expand into a third state from the compressed state that accommodates a gap and establishes the electrical connection.
- 21. (New) The contact of claim 20 wherein the conductive body is heat activated and expands into the third state when the body is exposed to a predetermined amount of heat.
- 22. (New) A method of using a heat activated conductive contact to establish an electrical connection between conductive elements comprising:

- accommodating the contact in a set and compressed state into a gap between a first electronic device and at least one second electronic device; and
- activating the contact by exposing the contact to a predetermined amount of heat that causes the contact to expand, wherein the contact accommodates the gap and establishes the electrical connection.
- 23. (New) The method of claim 22 wherein the contact comprises a shape memory material.
- 24. (New) The method of claim 23 wherein the shape memory material comprises a superelastic material.
- 25. (New) The method of claim 22 wherein the contact comprises a nickel titanium alloy.